

Enabling Connected Intelligence

European FD-SOI for Global Leadership

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FD-SOI is a technology with strong European roots



Our dual-track strategy: FinFET and FD-SOI

Performance Optimized

7LP Delivers

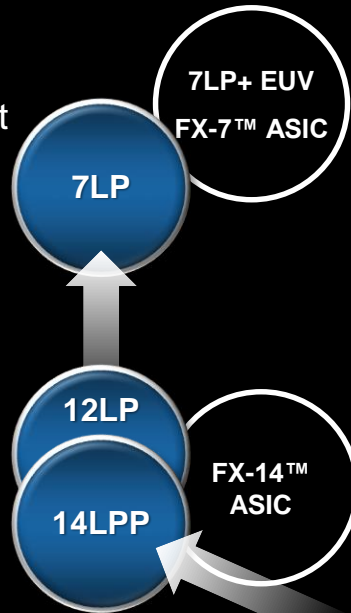
- Over 30% die cost reduction
- >40% performance improvement
- >60% power reduction

12LP Delivers

- 15% logic density improvement
- >10% performance boost

14LPP Delivers

- High performance
- Balanced cost



FinFET

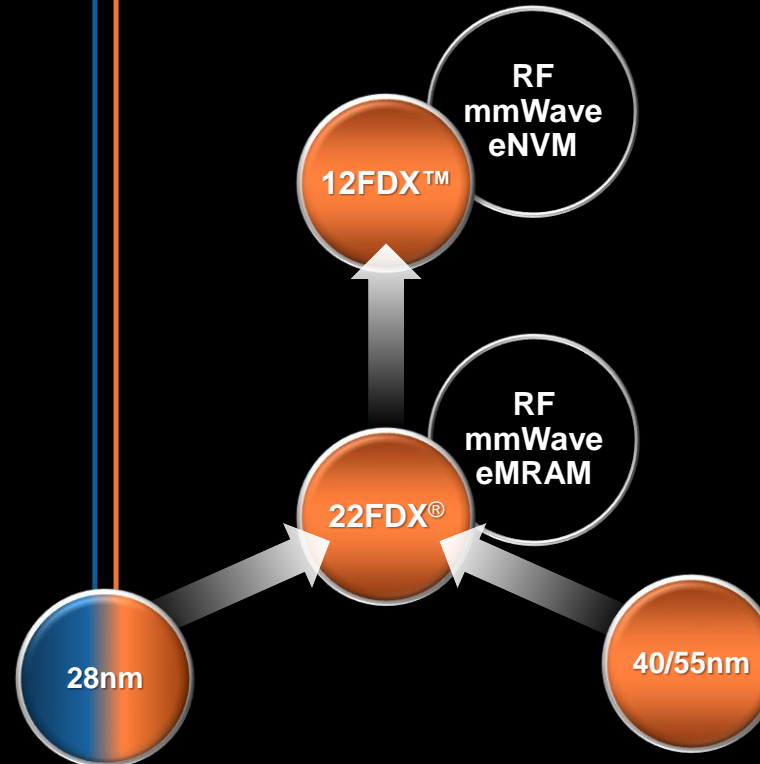
Power Optimized

12FDX Delivers

- Full-node scaling
- Energy efficiency
- Superior RF/Analog features
- Enhanced body-biasing

22FDX Delivers

- Superior RF/Analog features
- Lower power
- Smaller die
- Fewer masks
- Lower die cost



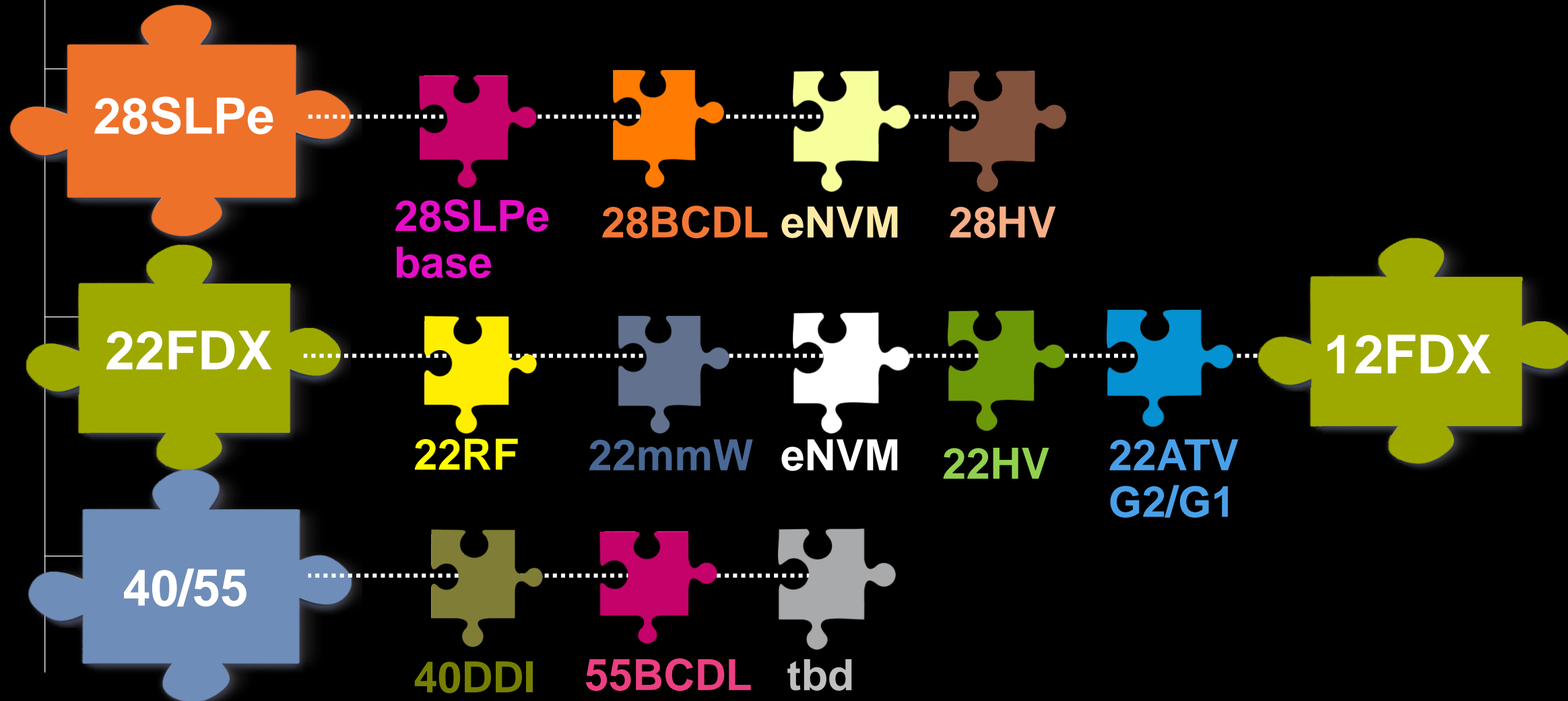
FD-SOI



...with Dresden as the COE

What Dresden is offering: Value Added Solutions (VAS)

Our Platform Strategy with VAS





22FDX[®] for IoT, Automotive and RF

Compelling

- FinFET-like performance for customer who still want to use planar devices
- Ultra-low voltage (0.4V)
- Ultra-low leakage (1pA/μm)
- MRAM integration for IoT and Auto-MCU
- Automotive grade 2 and 1, mmWave / Radar
- Benchmark RF performance (>400GHz), and PA integration

Relevant

- IoT - ARM, RISC-V processors for NB-IoT and AI – ML functions
- Automotive - ADAS /Vision, Infotainment, Body Electronics MCU, Radar
- RF - <6GHz: Connectivity (BLE, Wi-Fi, Zigbee), Cellular (3G, 4G LTE, 5G)
- RF – mmWave >26GHz, 5G infrastructure, ADC/DAC integration



22FDX/12FDX for IoT, Automotive and RF

STRATEGIC PARTNERSHIPS



“The **cost-effective performance and best-in-class energy efficiency** benefits of GF’s 22FDX platform...”

*Joël Hartmann, EVP, Digital Front-End
Manufacturing & Technology, STMicroelectronics*



“The **power consumption** we measured on the silicon have fully met the expectations and the result **is highly competitive for the ADAS** Computer Vision MPSoC market.”

*Dr. Jens Benndorf, Managing Director and
Co-Founder of Dream Chip Technologies*



“With over a decade of automotive industry experience, GF’s **22FDX delivers a performance on-demand, energy-efficient solution for our current and future radar technology** needs.”

Kobi Marenko, CEO of Arbe Robotics

22FDX Auto Qualified, Ready for Production

✓ Dresden, Fab 1 automotive qualified **Q1 2018**

✓ 22FDX fully qualified for automotive Grade 2 **NEW!**

✓ AEC Q-100; with ambient temp up to 105°C

✓ Prototyping ongoing, automotive production **Q3 2018**

✓ Features high voltage, eNVM auto grade, RF, mmWave

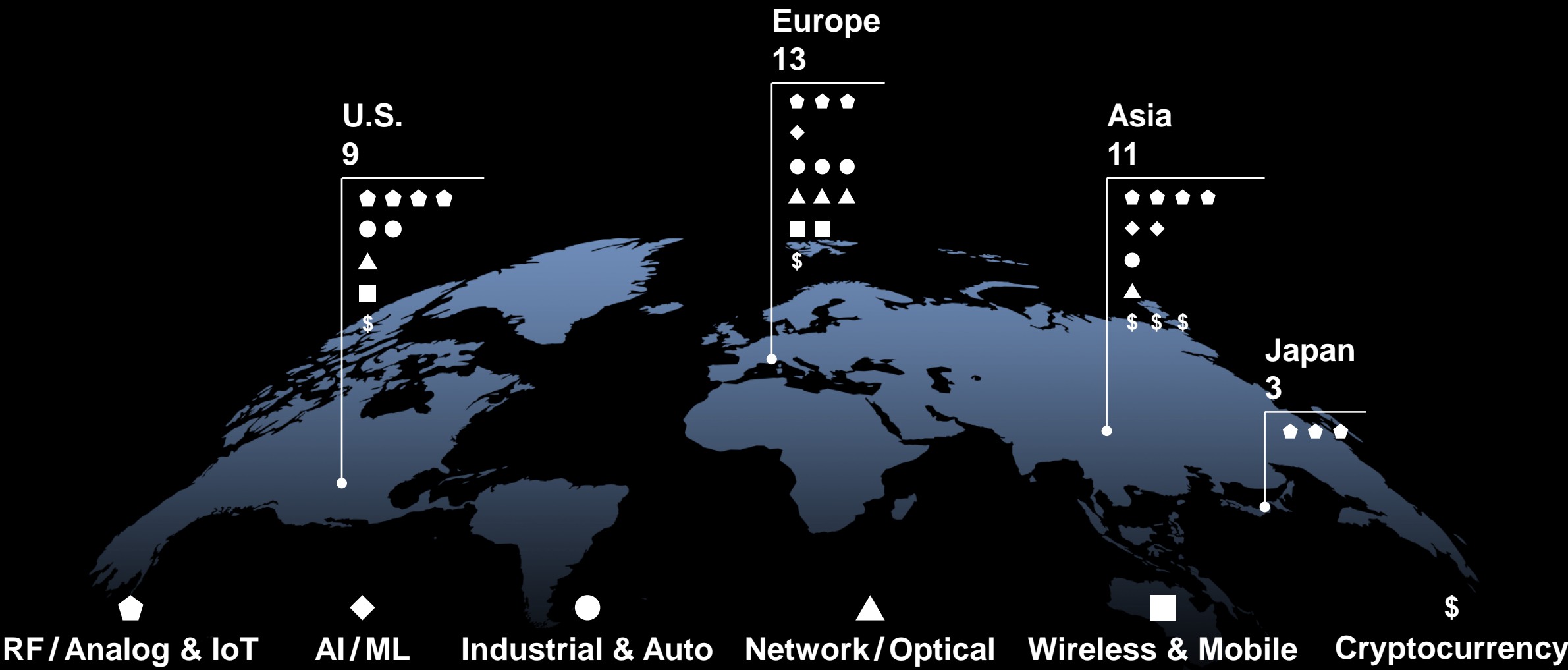
✓ Next-gen eMRAM in development **Q1 2019**

✓ 22FDX and Arbe Robotics 77GHz high resolution radar chipset



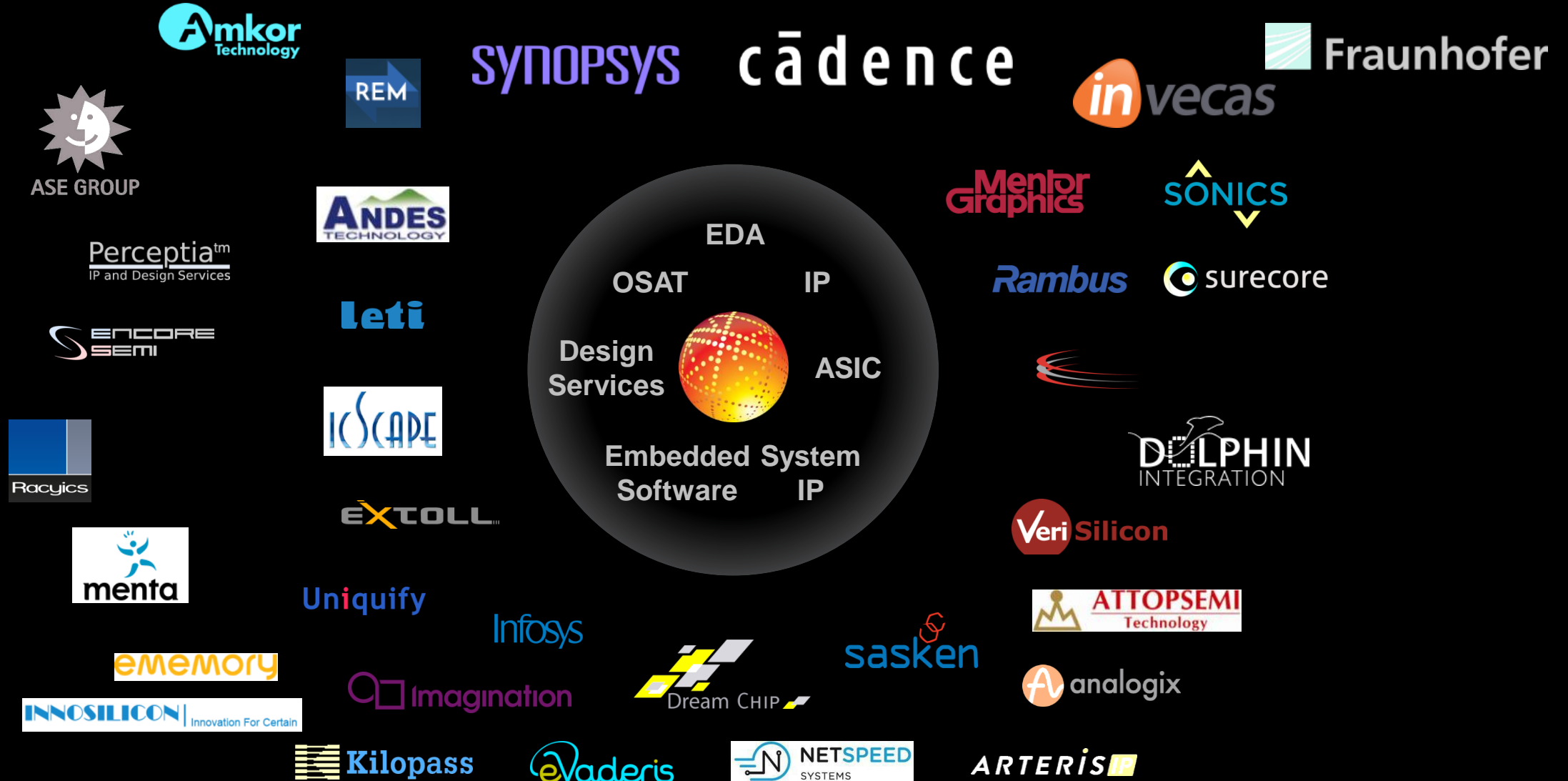
Marketplace Validation of 22FDX – Market Applications

36 client DWINs across the world

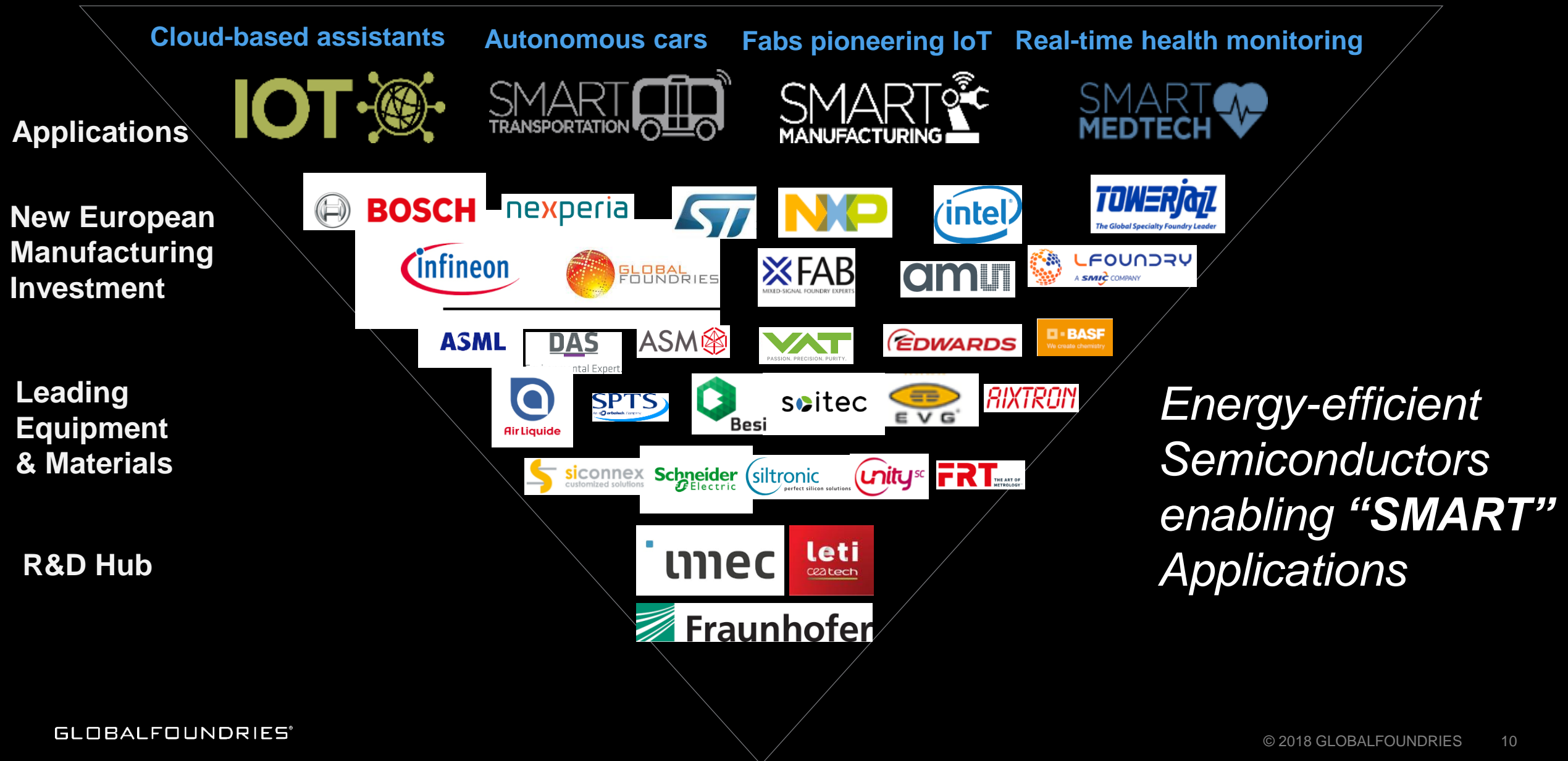


Ecosystem Partnering via **FDX**celerator™

Comprehensive design platform including IP and design flows



Positioning Europe in the Global Manufacturing Supply Chain



Advancing European value chains with FD-SOI





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